

High-Power NPN Silicon Transistors

... designed for use in industrial-military power amplifier and switching circuit applications.

- High Collector Emitter Sustaining —
 $V_{CE(sus)} = 100 \text{ Vdc (Min) — 2N6274}$
 $= 120 \text{ Vdc (Min) — 2N6275}$
 $= 150 \text{ Vdc (Min) — 2N6277}$
- High DC Current Gain —
 $h_{FE} = 30-120 @ I_C = 20 \text{ Adc}$
 $= 10 \text{ (Min) } @ I_C = 50 \text{ Adc}$
- Low Collector-Emitter Saturation Voltage —
 $V_{CE(sat)} = 1.0 \text{ Vdc (Max) } @ I_C = 20 \text{ Adc}$
- Fast Switching Times @ $I_C = 20 \text{ Adc}$
 $t_r = 0.35 \mu\text{s (Max)}$
 $t_s = 0.8 \mu\text{s (Max)}$
 $t_f = 0.25 \mu\text{s (Max)}$
- Complement to 2N6377-79

MAXIMUM RATINGS(1)

Rating	Symbol	2N6274	2N6275	2N6277	Unit
Collector-Base Voltage	V_{CB}	120	140	180	Vdc
Collector-Emitter Voltage	V_{CEO}	100	120	150	Vdc
Emitter-Base Voltage	V_{EB}	6.0			Vdc
Collector Current — Continuous	I_C	50			A dc
Peak					
Base Current	I_B	20			A dc
Total Device Dissipation @ $T_C = 25^\circ\text{C}$	P_D	250			Watts
Derate above 25°C		1.43			
Operating and Storage Junction Temperature Range	T_J, T_{stg}	-65 to +200			$^\circ\text{C}$

THERMAL CHARACTERISTIC

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	θ_{JC}	0.7	$^\circ\text{C}/\text{W}$

(1) Indicates JEDEC Registered Data.

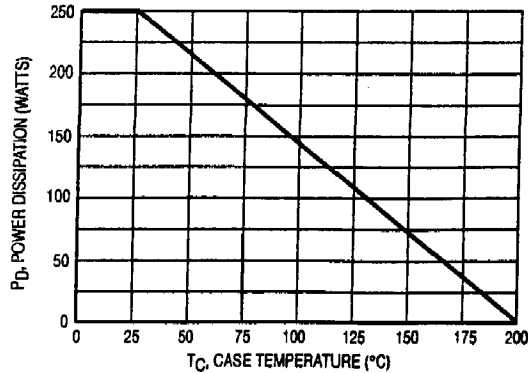
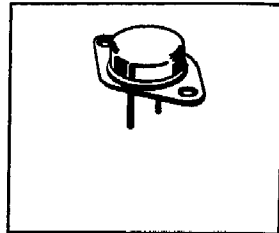


Figure 1. Power Derating

**2N6274
 2N6275
 2N6277**

**50 AMPERE
 POWER TRANSISTORS
 NPN SILICON
 100, 120, 140, 150 VOLTS
 250 WATTS**



2N6274 2N6275 2N6277

***ELECTRICAL CHARACTERISTICS** ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Collector-Emitter Sustaining Voltage (1) $I_C = 50 \text{ mAdc}, I_B = 0$	2N6274 2N6275 2N6277	$V_{CE(sus)}$ 100 120 150	— — —	Vdc
Collector Cutoff Current $(V_{CE} = 50 \text{ Vdc}, I_B = 0)$ $(V_{CE} = 60 \text{ Vdc}, I_B = 0)$ $(V_{CE} = 75 \text{ Vdc}, I_B = 0)$	2N6274 2N6275 2N6277	I_{CEO} — — —	— 50 50 50	μAdc
Collector Cutoff Current $(V_{CE} = \text{Rated } V_{CB}, V_{EB(off)} = 1.5 \text{ Vdc})$ $(V_{CE} = \text{Rated } V_{CB}, V_{EB(off)} = 1.5 \text{ Vdc}, T_C = 150^\circ\text{C})$		I_{CEX} — —	— 10 1.0	μAdc mAcd
Emitter Cutoff Current ($V_{BE} = 6.0 \text{ Vdc}, I_C = 0$)		I_{EBO}	— 100	μAcd

ON CHARACTERISTICS (1)

DC Current Gain $I_C = 1.0 \text{ Adc}, V_{CE} = 4.0 \text{ Vdc}$ $I_C = 20 \text{ Adc}, V_{CE} = 4.0 \text{ Vdc}$ $I_C = 50 \text{ Adc}, V_{CE} = 4.0 \text{ Vdc}$	h_{FE}	50 30 10	— 120 —	—
Collector-Emitter Saturation Voltage $I_C = 20 \text{ Adc}, I_B = 2.0 \text{ Adc}$ $I_C = 50 \text{ Adc}, I_B = 10 \text{ Adc}$	$V_{CE(sat)}$	— —	1.0 3.0	Vdc
Base-Emitter Saturation Voltage $I_C = 20 \text{ Adc}, I_B = 2.0 \text{ Adc}$ $I_C = 50 \text{ Adc}, I_B = 10 \text{ Adc}$	$V_{BE(sat)}$	— —	1.8 3.5	Vdc
Base-Emitter On Voltage ($I_C = 20 \text{ Adc}, V_{CE} = 4.0 \text{ Vdc}$)	$V_{BE(on)}$	—	1.8	Vdc

DYNAMIC CHARACTERISTICS

Current-Gain Bandwidth Product (2) ($I_C = 1.0 \text{ Adc}, V_{CE} = 10 \text{ Vdc}, f_{test} = 10 \text{ MHz}$)	f_T	30	—	MHz
Output Capacitance ($V_{CB} = 10 \text{ Vdc}, I_E = 0, f = 0.1 \text{ MHz}$)	C_{ob}	—	600	pF

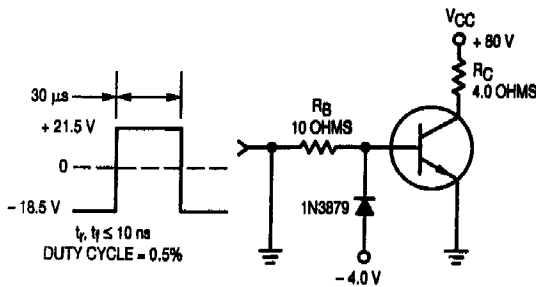
SWITCHING CHARACTERISTICS

Rise Time $(V_{CC} = 80 \text{ Vdc}, I_C = 20 \text{ Adc}, I_{B1} = 2.0 \text{ Adc}, V_{BE(off)} = 5.0 \text{ Vdc})$	t_r	—	0.35	μs
Storage Time $(V_{CC} = 80 \text{ Vdc}, I_C = 20 \text{ Adc}, I_{B1} = I_{B2} = 2.0 \text{ Adc})$	t_s	—	0.80	μs
Fall Time $(V_{CC} = 80 \text{ Vdc}, I_C = 20 \text{ Adc}, I_{B1} = I_{B2} = 2.0 \text{ Adc})$	t_f	—	0.25	μs

* Indicates JEDEC Registered Data.

(1) Pulse Test: Pulse Width $\leq 300 \mu\text{s}$, Duty Cycle $\leq 2.0\%$.

(2) $f_T = |h_{fe}| \cdot f_{test}$



NOTE: For information of Figures 3 and 6, R_B and R_C were varied to obtain desired test conditions.

Figure 2. Switching Time Test Circuit

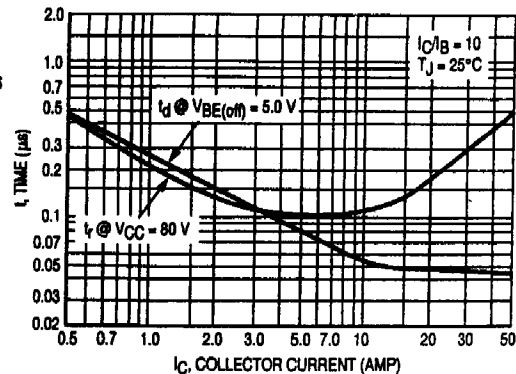


Figure 3. Turn-On Time

